

## **REMARKS/ARGUMENTS**

Claims 1-11 are pending in the application. Claims 1-11 stand rejected. Claims 12-13 have been added to the application. In light of the following, all new and previously unallowed claims are now in condition for allowance.

### **Rejection of Claims 1, 2 and 9-10 Under 35 U.S.C. § 102(e) As Being Anticipated By Hyoudo**

#### **Claim 1**

Claim 1 recites providing a first wafer and a second wafer, removing a portion from the first wafer to form a gasket, and forming a pad on the second wafer.

For example, referring, *e.g.*, to FIGS. 3A-3D and paragraphs 16-20 of the patent application, a gasket 201 is formed from a first wafer 203. The gasket is formed by, for example, etching the wafer 203. Additionally, a mating pad 305 is formed on a second wafer 207.

Hyoudo, on the other hand, fails to teach removing a portion from a first wafer to form a gasket, or forming a pad on a second wafer. Hyoudo at, *e.g.*, to FIGS. 4A-4B and col. 3, lines 24-46 of, teaches a cover member 31a (which the Examiner regards as a first wafer) having a plurality of depressions 24 positioned to correspond to each of element mounting sections 50 disposed on a substrate 21 (which the Examiner regards as a second wafer). Although the term "gasket" is not used in the Hyoudo reference, the Examiner seems to indicate that because the cover member 31a includes the depressions 24, the cover member must necessarily include one or more gaskets. However, even if the cover member 31a may properly be regarded as including a gasket, Hyoudo is completely silent on the manner in which the cover member acquires its configuration. As such, in no manner does Hyoudo teach that a portion or portions of the cover member (first wafer) 31a are removed in order to form a gasket. Moreover, in no manner does Hyoudo teach forming a pad on the substrate (second wafer) 21.

**Claims 2 and 9-10**

Claims 2 and 9-10 are patentable by virtue of their dependency from claim 1.

**Rejection of Claims 3-8 and 11 Under 35 U.S.C. § 103(a) As Being  
Unpatentable Over Hyoudo**

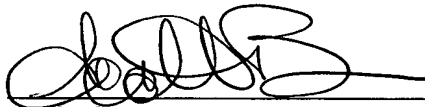
Claims 3-8 and 11 are patentable by virtue of their dependency from claim 1.

**CONCLUSION**

In view of the foregoing, claims 1-13 are in condition for allowance. The issuance of a formal Notice of Allowance at an early date is respectfully requested. If the Examiner believes that a telephone conference would expedite prosecution of this application, please telephone the undersigned at 425.455.5575. In the event additional fees are due as a result of this amendment, you are hereby authorized to charge such payment to Deposit Account No. 07-1897.

Respectfully submitted,  
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